Display Future Ltd
www.displayfuture.com

LCD MODULE SPECIFICATION

Model: DF-TFR0260FB-M1

This module uses ROHS materials

For customer acceptance

Customer		date
Approved		
Comments		

The standard product specification may change without prior notice in order to improve performance or quality. Please contact Display Future Ltd for updated specification and product status before design for the standard product or release of the order.	Revision	1.0
	Engineering	
	Date	2018/01/4
	Our Reference	

REVISION RECORD

REV NO.	REV DATE	CONTENTS	REVISED PAGE NO.
1.0	2017-06-26	First Release	

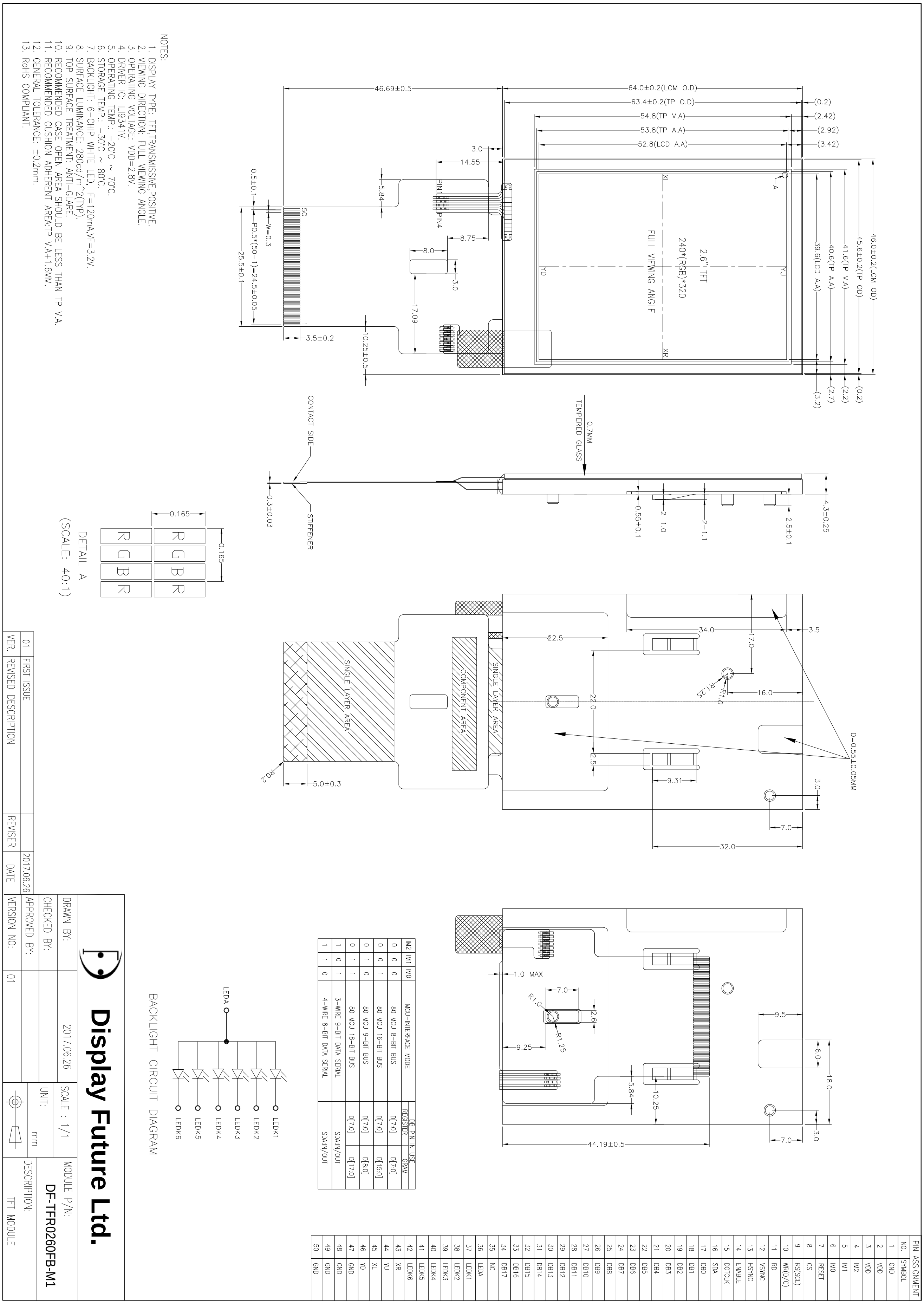
CONTENTS

■ GENERAL INFORMATION

Item	Contents	Unit
LCD type	TFT/Transmissive/Positive	/
Size	2.6	Inch
Viewing direction	Full viewing angle	O' Clock
LCM (W × H × D)	46.00×64.00×4.30	mm^3
Active area (W×H)	39.60×52.80	mm^2
Pixel pitch (W×H)	0.165×0.165	mm^2
Number of dots	240 (RGB) × 320	/
Driver IC	ILI9341V	/
Backlight type	6 LEDs	/
Interface type	8-/9-/16-/18-bit CPU,6-/16-/18-bit RGB, 3-/4-wire SPI	/
Color depth	262K	/
Pixel configuration	R.G.B vertical stripe	/
Top polarizer surface treatment	Anti-glare	/
Input voltage	2.8	V
With/Without TSP	With RTP	/
TP surface treatment	TBD	/
Weight	TBD	g

Note 1: RoHS compliant;
Note 2: LCM weight tolerance: ± 5% .

■ EXTERNAL DIMENSIONS



■ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Min	Max	Unit
Supply voltage	VDD	-0.3	4.6	V
Backlight forward current(one LED)	I_{LED}	-	30	mA
Operating temperature	T_{OP}	-20	70	°C
Storage temperature	T_{ST}	-30	80	°C

Note :The absolute maximum rating values of this product are not allowed to be exceeded at any times.Should a module be used with any of the absolute maximum ratings exceeded,the characteristics of the module may not be recovered,or in an extreme case,the module may be permanently destroyed.

■ELECTRICAL CHARACTERISTICS

Parameter	Symbol	Min	Typ	Max	Unit
Supply voltage	VDD	2.5	2.8	3.3	V
Input voltage ' H ' level	V_{IH}	0.7VDD	-	VDD	V
Input voltage ' L ' level	V_{IL}	VSS	-	0.3VDD	V
Output voltage ' H ' level	V_{OH}	0.8VDD	-	VDD	V
Output voltage ' L ' level	V_{OL}	VSS	-	0.2VDD	V

■ BACKLIGHT CHARACTERISTICS

Item	Symbol	Min.	Typ.	Max.	Unit	Condition
Forward voltage	Vf	2.8	3.2	3.4	V	Ta=25±2°C, 60%RH±5%
Forward current	I f	-	120	-	mA	
Power consumption	W_{BL}	-	384	-	mW	
Operating life time	-	30,000	-	-	Hrs	

Note :

Operating life time means brightness goes down to 50% initial brightness;

The life time of LED will be reduced if LED is driven by high current,high ambient temperature and humidity conditions;

■ELECTRO-OPTICAL CHARACTERISTICS

Item		Symbol	Condition	Min	Typ	Max	Unit	Remark	Note
Response time		Tr+Tf	θ=0° ∅=0° Ta=25℃	-	35	50	ms	FIG 1.	4
Contrast ratio		Cr		400	500	-	---	FIG 2.	1
Luminance uniformity		δ WHITE		80	-	-	%	FIG 2.	3
Surface Luminance		Lv		220	280	-	cd/m^2	FIG 2.	2
Viewing angle range		θ	∅ = 90°	60	80	-	deg	FIG 3.	6
			∅ = 270°	60	80	-	deg	FIG 3.	
			∅ = 0°	60	80	-	deg	FIG 3.	
			∅ = 180°	60	80	-	deg	FIG 3.	
CIE (x, y) chromaticity	Red	x	θ=0° ∅=0° Ta=25℃	0.565	0.615	0.665		FIG 2.	5
		y		0.315	0.365	0.415			
	Green	x		0.295	0.345	0.395			
		y		0.555	0.605	0.655			
	Blue	x		0.098	0.148	0.198			
		y		0.053	0.103	0.153			
	White	x		0.238	0.288	0.338			
		y		0.275	0.325	0.375			

Note 1. Contrast Ratio(CR) is defined mathematically as For more information see FIG 2.

$$\text{Contrast Ratio} = \frac{\text{Average Surface Luminance with all white pixels (P1, P2, P3, P4, P5)}}{\text{Average Surface Luminance with all black pixels (P1, P2, P 3,P4, P5)}}$$

Note 2. Surface luminance is the LCD surface from the surface with all pixels displaying white. For more information see FIG 2.

Lv = Average Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)

Note 3. The uniformity in surface luminance ， δ WHITE is determined by measuring luminance at each test position 1 through 5, and then dividing the maximum luminance of 5 points luminance by minimum luminance of 5 points luminance. For more information see FIG 2.

$$\delta\ \text{WHITE} = \frac{\text{Minimum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)}}{\text{Maximum Surface Luminance with all white pixels (P1, P2, P 3, P4, P5)}}$$

Note 4. Response time is the time required for the display to transition from White to black(Rise Time, Tr) and from black to white(Decay Time, Tf). For additional information see FIG 1. The test equipment is Autronic-Melchers's ConoScope. Series.

Note 5. CIE (x, y) chromaticity，The x, y value is determined by measuring luminance at each test position 1 through 5,and then make average value.

Note 6. Viewing angle is the angle at which the contrast ratio is greater than 2. For TFT module the conrast ratio is greater than 10. The angles are determined for the horizontal or x axis and the vertical or y axis with respect to the z axis which is normal to the LCD surface. For more information see FIG 3.

Note 7. For viewing angle and response time testing, the testing data is base on Autronic-Melchers's ConoScope. Series Instruments For contrast ratio, Surface Luminance, Luminance uniformity, CIE The test data is base on TOPCON's BM-5 photo detector.

FIG. 1 The definition of Response Time

The response time is defined as the following figure and shall be measured by switching the input signal for "black" and "white".

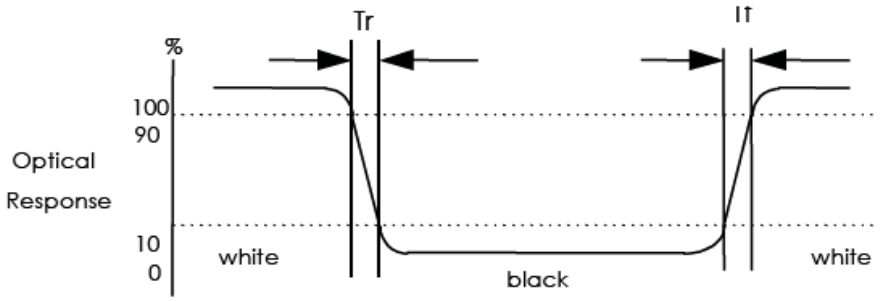
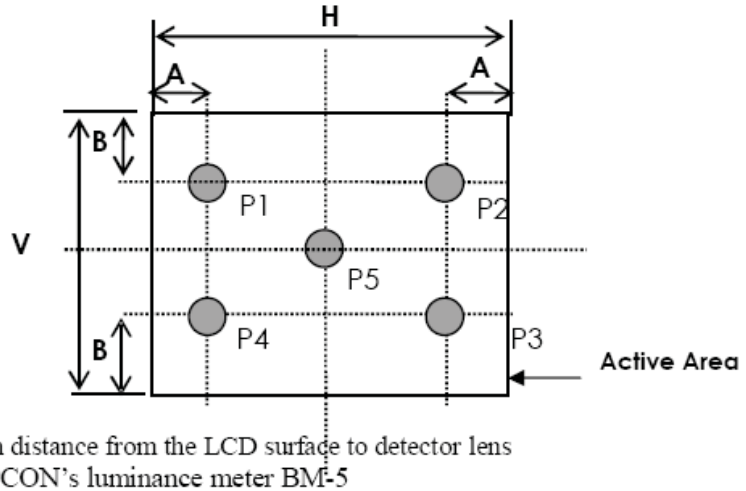
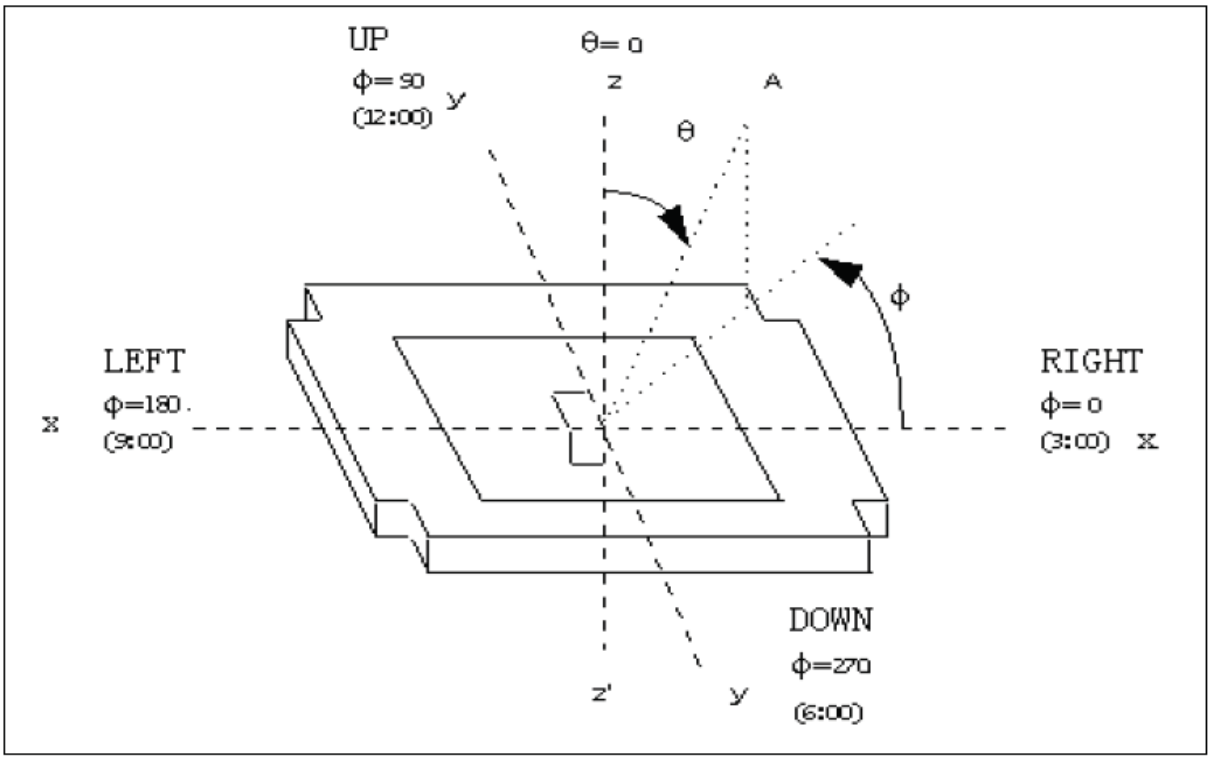


FIG. 2 Measuring method for Contrast ratio, surface luminance, Luminance uniformity , CIE (x, y) chromaticity



A : 5 mm
B : 5 mm
H,V : Active Area
Light spot size ∅=7mm, 500mm distance from the LCD surface to detector lens
measurement instrument is TOPCON's luminance meter BM-5

FIG. 3 The definition of viewing angle



■INTERFACE DESCRIPTION

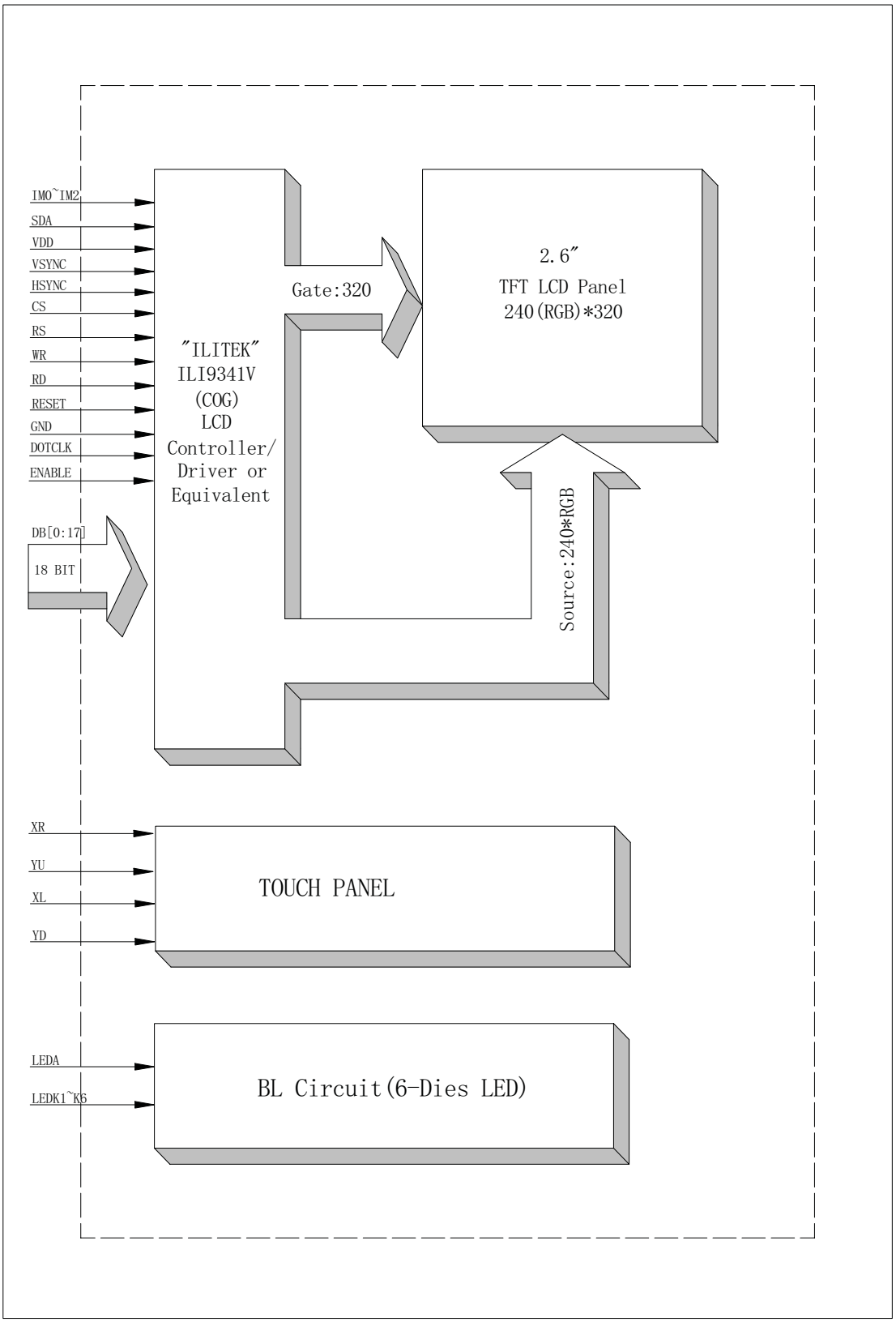
Pin No.	Symbol	Description
1	GND	Power ground.
2	VDD	Power supply.
3	VDD	Power supply.
4	IM2	Select the MCU interface mode.(Note)
5	IM1	
6	IM0	
7	RESET	Reset pin
8	CS	Chip select input pin (“Low” enable).
9	RS(SCL)	Data or command select
10	WR(D/C)	Write data signal
11	RD	Read data signal
12	VSYNC	Vertical sync signal
13	HSYNC	Horizontals ync signal
14	ENABLE	Data input enable. Active High to enable the data input.
15	DOTCLK	Clock signal; latching data at the falling edge.
16	SDA	Serial Data.
17	DB0	Data bus
18	DB1	Data bus
19	DB2	Data bus
20	DB3	Data bus
21	DB4	Data bus
22	DB5	Data bus
23	DB6	Data bus
24	DB7	Data bus
25	DB8	Data bus
26	DB9	Data bus
27	DB10	Data bus
28	DB11	Data bus
29	DB12	Data bus
30	DB13	Data bus
31	DB14	Data bus
32	DB15	Data bus
33	DB16	Data bus
34	DB17	Data bus
35	NC	No connect
36	LEDA	Anode of LED backlight
37	LEDK1	Cathode of LED backlight
38	LEDK2	Cathode of LED backlight
39	LEDK3	Cathode of LED backlight
40	LEDK4	Cathode of LED backlight

41	LEDK5	Cathode of LED backlight
42	LEDK6	Cathode of LED backlight
43	XR	TP pin.
44	YU	TP pin.
45	XL	TP pin.
46	YD	TP pin.
47	GND	Power ground.
48	GND	Power ground.
49	GND	Power ground.
50	GND	Power ground.

Note:

IM2	IM1	IM0	MCU-Interface mode	DB pin in use	
				Register/Content	GRAM
0	0	0	80 MCU-8bit bus	D[7:0]	D[7:0]
0	0	1	80 MCU-16bit bus	D[7:0]	D[15:0]
0	1	0	80 MCU-9bit bus	D[7:0]	D[8:0]
0	1	1	80 MCU-18bit bus	D[7:0]	D[17:0]
1	0	1	3-Wire 9-bit data serial	SDA:IN/OUT	
1	1	0	4-Wire 8-bit data serial	SDA:IN/OUT	

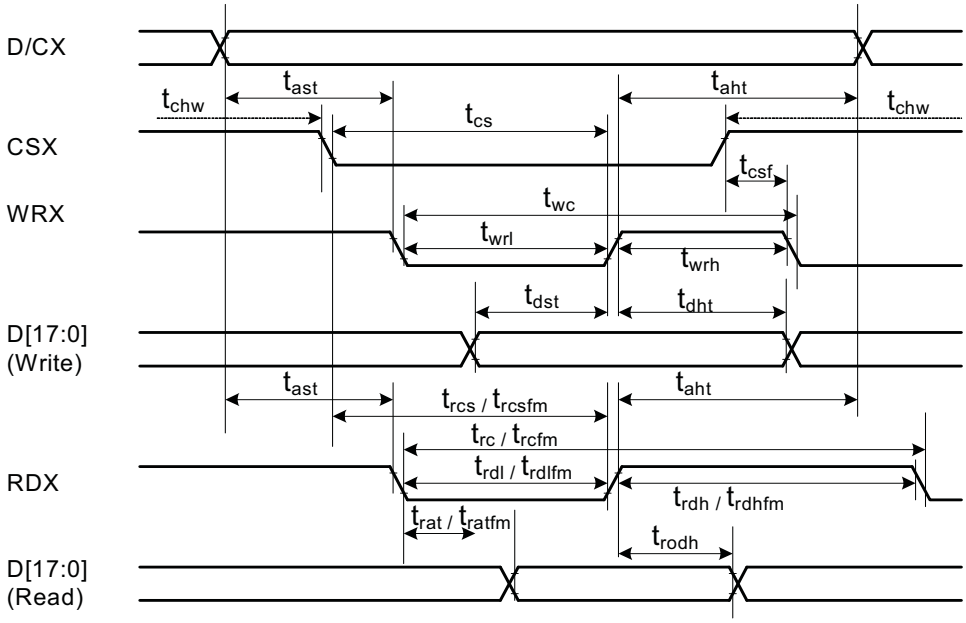
■BLOCK DIAGRAM



■ APPLICATION NOTES

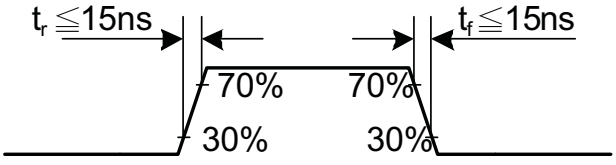
1 Timing Characteristics

1.1 Display Parallel 18/16/9/8-bit Interface Timing Characteristics(8080-I system)

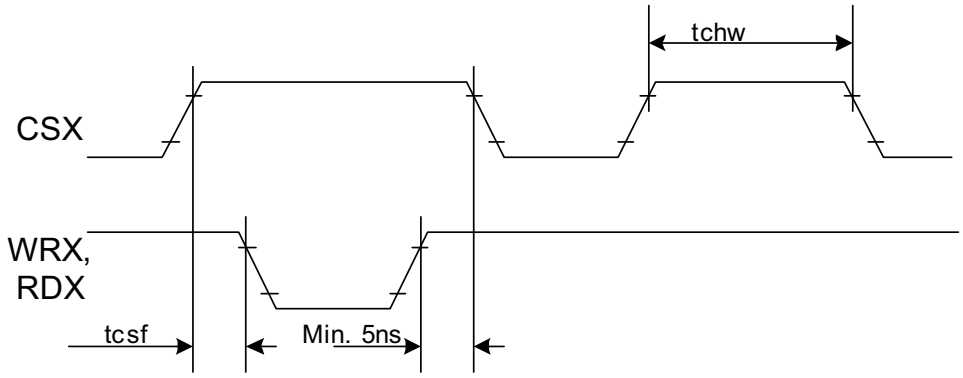


Signal	Symbol	Parameter	min	max	Unit	Description
DCX	tast	Address setup time	0	-	ns	
	taht	Address hold time (Write/Read)	0	-	ns	
CSX	tchw	CSX “H” pulse width	0	-	ns	
	tcs	Chip Select setup time (Write)	15	-	ns	
	trcs	Chip Select setup time (Read ID)	45	-	ns	
	trcsfm	Chip Select setup time (Read FM)	355	-	ns	
	tcsf	Chip Select Wait time (Write/Read)	10	-	ns	
WRX	twc	Write cycle	66	-	ns	
	twrh	Write Control pulse H duration	15	-	ns	
	twrl	Write Control pulse L duration	15	-	ns	
RDX (FM)	trcfm	Read Cycle (FM)	450	-	ns	
	trdhfm	Read Control H duration (FM)	90	-	ns	
	trdlfm	Read Control L duration (FM)	355	-	ns	
RDX (ID)	trc	Read cycle (ID)	160	-	ns	
	trdh	Read Control pulse H duration	90	-	ns	
	trdl	Read Control pulse L duration	45	-	ns	
D[17:0], D[15:0], D[8:0], D[7:0]	tdst	Write data setup time	10	-	ns	For maximum CL=30pF For minimum CL=8pF
	tdht	Write data hold time	10	-	ns	
	trat	Read access time	-	40	ns	
	tratfm	Read access time	-	340	ns	
	trod	Read output disable time	20	80	ns	

Note: Ta = -30 to 70 °C, VDD=2.5V to 3.3V, VSS=0V

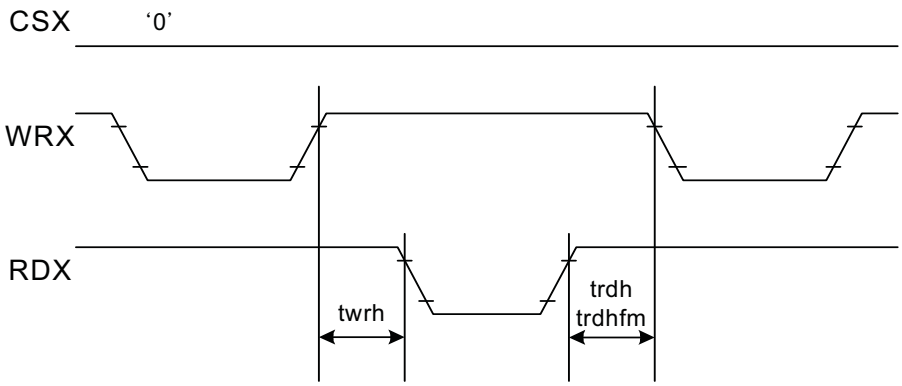


CSX timings :



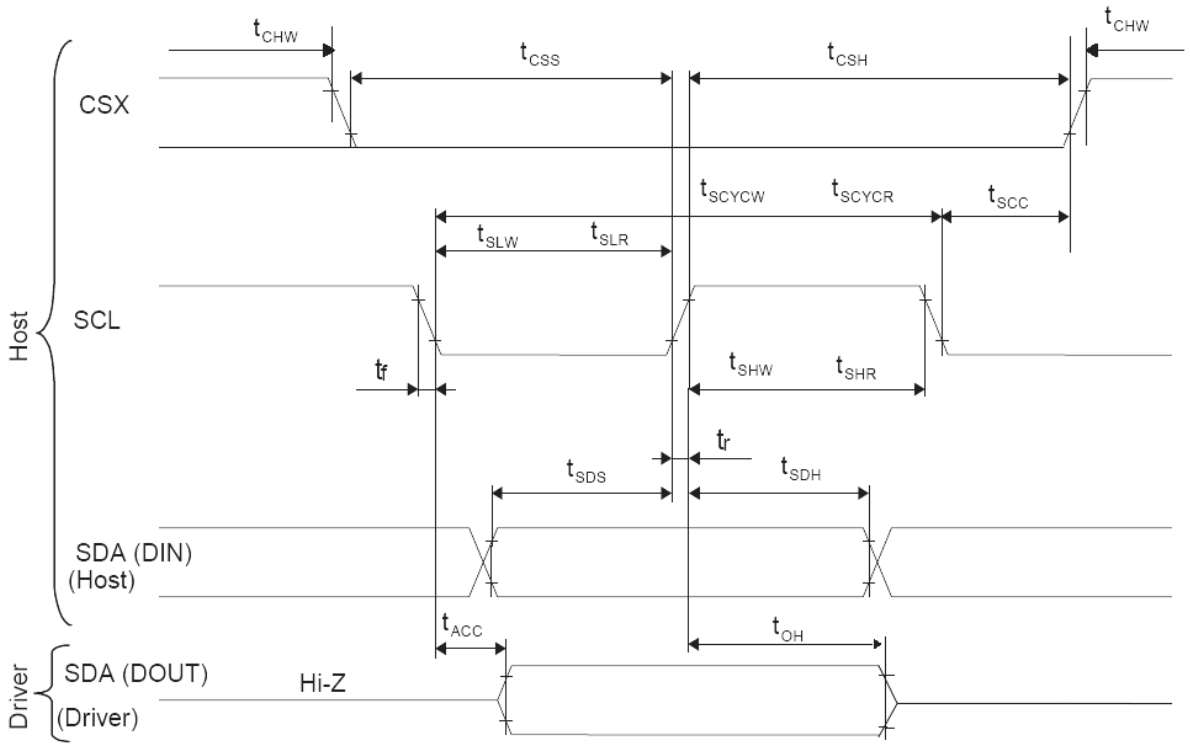
Note: Logic high and low levels are specified as 30% and 70% of VDD for Input signals.

Write to read or read to write timings:



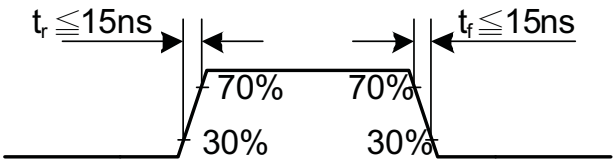
Note: Logic high and low levels are specified as 30% and 70% of VDD for Input signals.

1.3 Display Serial Interface Timing characteristics(3-line SPI system)

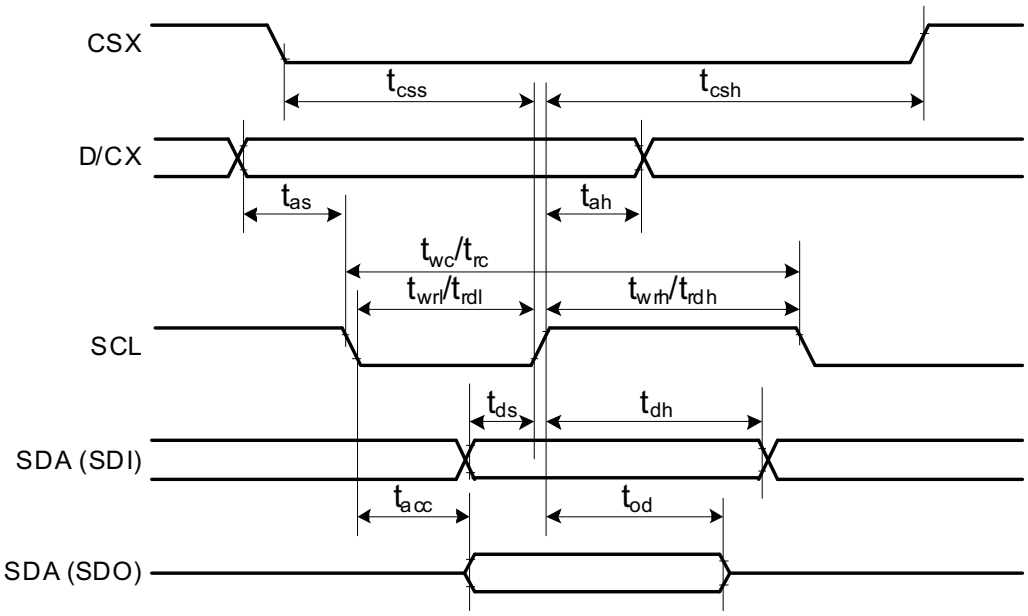


Signal	Symbol	Parameter	min	max	Unit	Description
SCL	tscycw	Serial Clock Cycle (Write)	100	-	ns	
	tshw	SCL “H” Pulse Width (Write)	40	-	ns	
	tslw	SCL “L” Pulse Width (Write)	40	-	ns	
	tscycr	Serial Clock Cycle (Read)	150	-	ns	
	tshr	SCL “H” Pulse Width (Read)	60	-	ns	
	tslr	SCL “L” Pulse Width (Read)	60	-	ns	
SDA / SDI (Input)	tsds	Data setup time (Write)	30	-	ns	
	tsdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	
	toh	Output disable time (Read)	10	50	ns	
CSX	tscc	SCL-CSX	20	-	ns	
	tchw	CSX “H” Pulse Width	40	-	ns	
	tcss	CSX-SCL Time	60	-	ns	
	tcsh		65	-	ns	

Note: Ta = 25 °C, VDD =2.5V to 3.3V, GND=VSS=0V

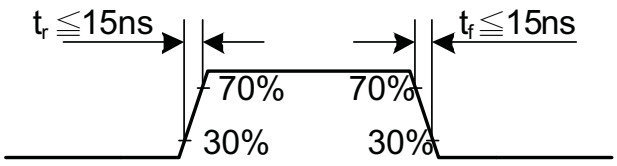


1.4 Display Serial Interface Timing characteristics(4-line SPI system)

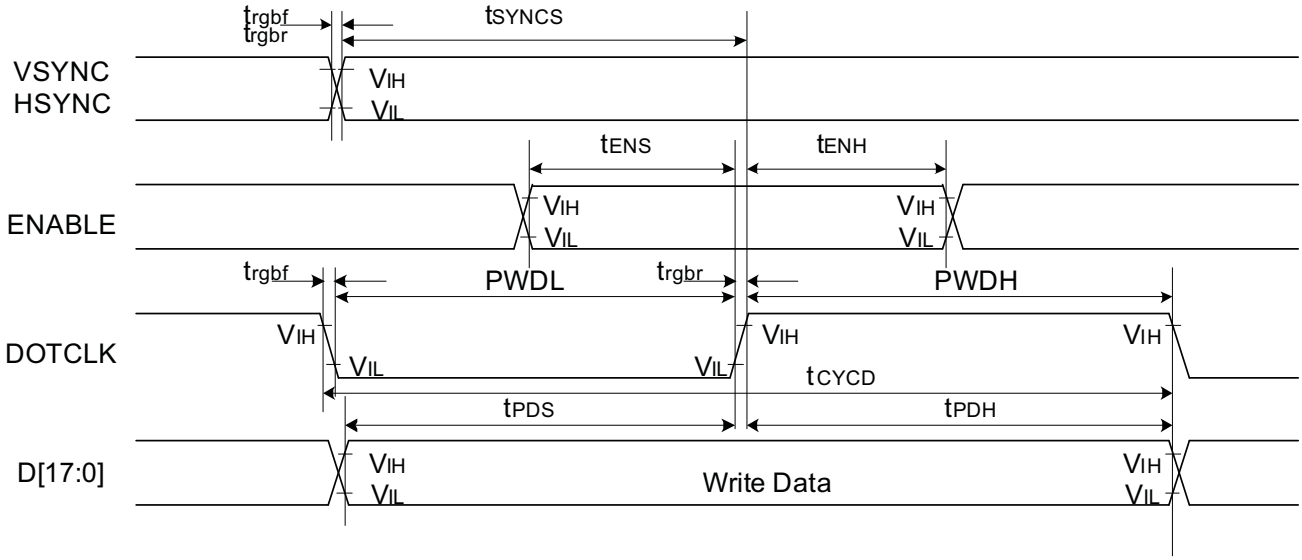


Signal	Symbol	Parameter	min	max	Unit	Description
CSX	tcss	Chip select time (Write)	40	-	ns	
	tcsh	Chip select hold time (Read)	40	-	ns	
SCL	twc	Serial clock cycle (Write)	100	-	ns	
	twrh	SCL “H” pulse width (Write)	40	-	ns	
	twrl	SCL “L” pulse width (Write)	40	-	ns	
	trc	Serial clock cycle (Read)	150	-	ns	
	trdh	SCL “H” pulse width (Read)	60	-	ns	
	trdl	SCL “L” pulse width (Read)	60	-	ns	
D/CX	tas	D/CX setup time	10	-		
	tah	D/CX hold time (Write / Read)	10	-		
SDA / SDI (Input)	tds	Data setup time (Write)	30	-	ns	
	tdh	Data hold time (Write)	30	-	ns	
SDA / SDO (Output)	tacc	Access time (Read)	10	-	ns	For maximum CL=30pF
	tod	Output disable time (Read)	10	50	ns	For minimum CL=8pF

Note: Ta = 25 °C, VDD=2.5V to 3.3V, GND=VSS=0V

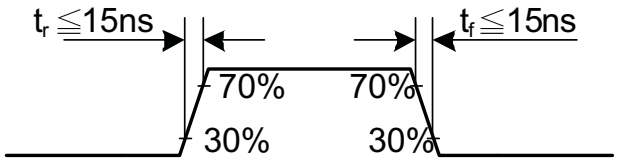


1.5 Parallel 18/16/6-bit RGB Interface Timing Characteristics



Signal	Symbol	Parameter	min	max	Unit	Description
VSYNC / HSYNC	t_{SYNCS}	VSYNC/HSYNC setup time	15	-	ns	18/16-bit bus RGB interface mode
	t_{SYNCH}	VSYNC/HSYNC hold time	15	-	ns	
DE	t_{ENS}	DE setup time	15	-	ns	
	t_{ENH}	DE hold time	15	-	ns	
D[17:0]	t_{POS}	Data setup time	15	-	ns	
	t_{PDH}	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level period	15	-	ns	
	PWDL	DOTCLK low-level period	15	-	ns	
	t_{CYCD}	DOTCLK cycle time	100	-	ns	
	t_{rgbr} , t_{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	
VSYNC / HSYNC	t_{SYNCS}	VSYNC/HSYNC setup time	15	-	ns	6-bit bus RGB interface mode
	t_{SYNCH}	VSYNC/HSYNC hold time	15	-	ns	
DE	t_{ENS}	DE setup time	15	-	ns	
	t_{ENH}	DE hold time	15	-	ns	
D[17:0]	t_{POS}	Data setup time	15	-	ns	
	t_{PDH}	Data hold time	15	-	ns	
DOTCLK	PWDH	DOTCLK high-level pulse period	15	-	ns	
	PWDL	DOTCLK low-level pulse period	15	-	ns	
	t_{CYCD}	DOTCLK cycle time	50	-	ns	
	t_{rgbr} , t_{rgbf}	DOTCLK,HSYNC,VSYNC rise/fall time	-	15	ns	

Note: Ta = -30 to 70 °C, VDD=2.5V to 3.3V, GND=VSS=0V



■ TOUCH PANEL SPECIFICATIONS

1. ELECTRICAL CHARACTERISTICS

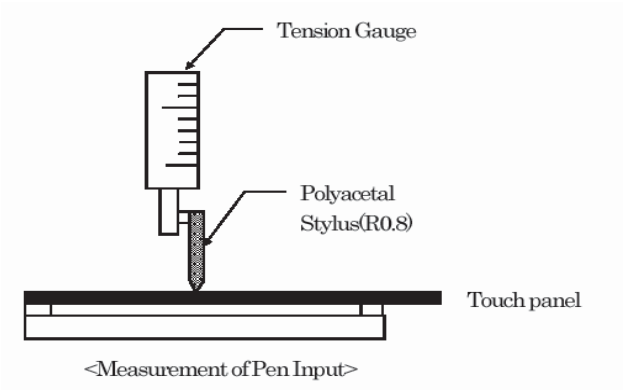
Item	Value			Unit	Remark
	Min.	Typ.	Max.		
Linearity	-	-	1.5	%	Analog X and Y directions
Terminal Resistance	100	-	550	Ω	X(Film side)
	250	-	850	Ω	Y(Glass side)
Insulation resistance	-	-	-	MΩ	DC 25 V
Voltage	-	-	5	V	DC
Chattering	-	-	10	ms	100kΩ pull-up
Transparency	78	-	-	%	

Note: Avoid operating with hard or sharp material such as a ball point pen or a mechanical pencil except a polyacetal pen (tip R0.8mm or less) or a finger.

2. MECHANICAL & RELIABILITY CHARACTERISTICS

Item	Value			Unit	Remark
	Min.	Typ.	Max.		
Active force	-	-	120	gf	Note 1
Durability-surface scratching	Write 100,000	-	-	characters	Note 2
Durability-surface pitting	1,000,000	-	-	touches	Note 3
Surface hardness	3	-	-	H	

Note 1: Active force test condition
(1) Input DC 5V on X direction, Drop off Polyacetal Stylus (R0.8), until output voltage stabilize, then get the activation force
(2) R8.0mm Silicon rubber for finger Activation force test
(3) Test point: 9 points

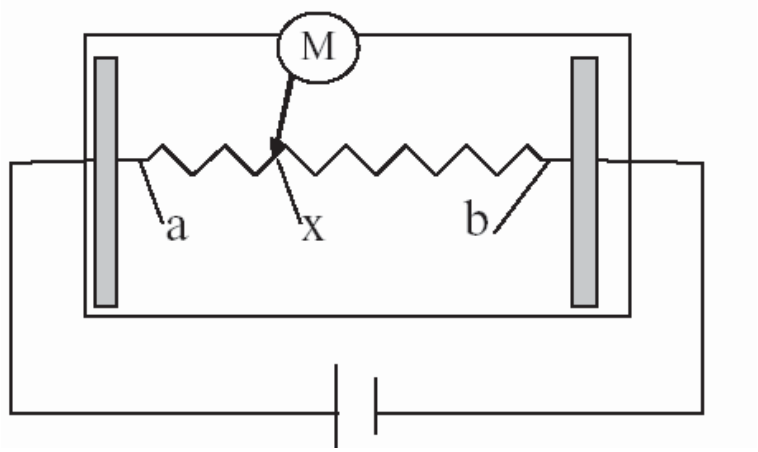


<Measurement of Pen Input>

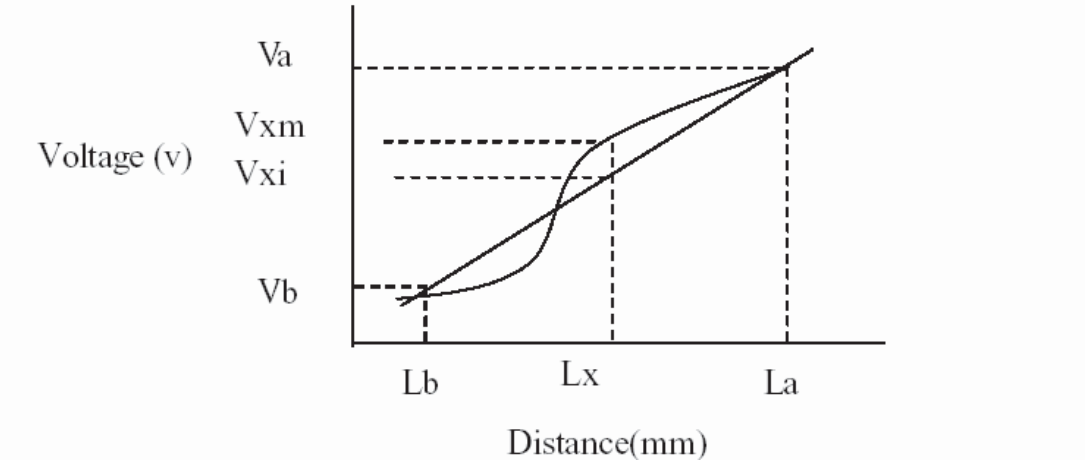
Note 2: Measurement for surface area.
-Scratch 100,000 times straight line on the film with a stylus change every 20,000 times.
-Force: 120gf.
-Speed: 60mm/sec.
-Stylus: R0.8 polyacetal tip.

Note 3: Pit 1,000,000 times on the film with a R0.8 silicon rubber.
-Force: 120gf.
-Speed: 2times/sec.

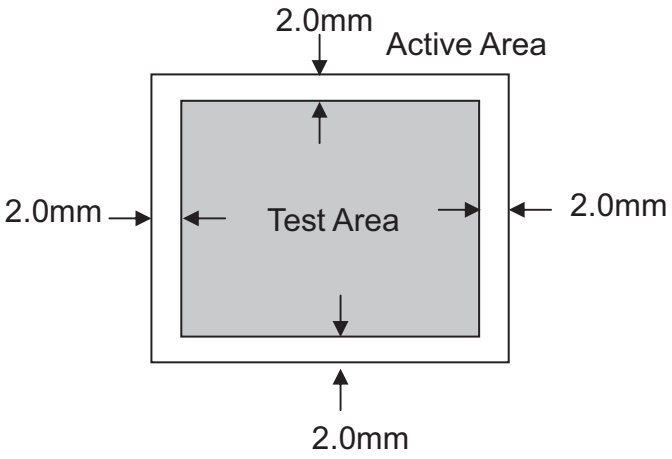
3. LINEARITY DEFINITION



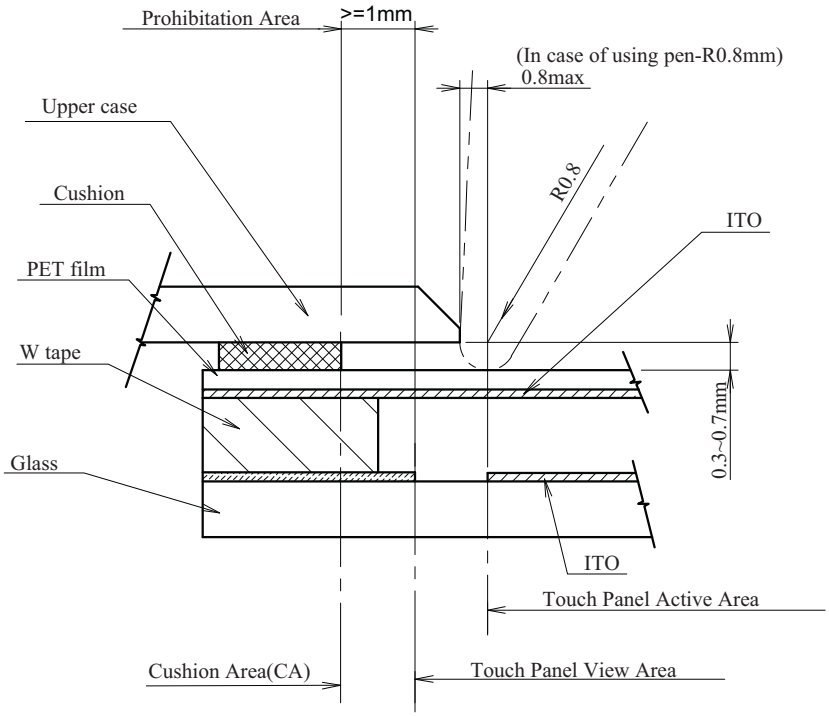
Va: maximum voltage in the active area of touch panel
Vb: minimum voltage in the active area of touch panel
X: random measuring point
Vxm: actual voltage of Lx point
Vxi: theoretical voltage of Lx point



Linearity = [|Vxi-Vxm |/(Va-Vb)]*100%
Note: Test area is as follows and operation force is 150gf.



3. DESIGN GUIDANCE FOR THE UPPER CASE AND CUSHION



Note 1:Upper case opening

a. Please place the upper case opening to maintain the operation by a stylus pen inside the TP response area.
b. The any pressures in the area between TP response area and TP viewing area is prohibited.
c. Please use the appropriate material(PMMA,PC,etc.) as the upper case.

Note 2:Cushion design

a. Please put the cushion on the upper case.
b. Do not use an adhesive tape to stick on the TP suface.
c. Please position the cushion over the cushion area to avoid a short.

■ RELIABILITY TEST

No.	Test Item	Test Condition	Remarks
1	High Temperature Storage Test	80℃±2℃/240Hrs.	Note2
2	Low Temperature Storage Test	-30℃±2℃/240Hrs.	Note1,2
3	High Temperature Operation Test	70℃±2℃/240Hrs.	
4	Low Temperature Operation Test	-20℃±2℃/240Hrs.	Note1
5	High Temperature and High Humidity Operation Test	60±5℃, 90%RH 240Hrs.	Note1,2
6	Thermal Shock Test (Non-operating)	-30±2℃(30Min.)~25±2℃(5Min.)~80±2℃(30Min.) 10Cycles	
7	Vibration Test (Non-operating)	Frequency:10~55Hz Amplitude: 1.5mm Sweep Time: 11Mins Test Period: 6 Cycles For Each Direction Of X, Y, Z (Packing Condition)	
8	Shock Test (Non-operating)	100G, 6Ms Direction: ±X, ±Y, ±Z Cycle: 3 Times	
9	Electro Static Discharge Test (Non-operating)	Voltage: ±8KV, R:330Ω, C:150pF, Air Discharge, 10 Times. (Packing Condition)	

Note 1： Without water condensation

Note 2： The function test shall be conducted after 2 hours storage at the room temperature and humidity after removed from the test chamber.

■ INSPECTION CRITERION

OUTGOING QUALITY STANDARD	PAGE 1 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	

This specification is made to be used as the standard acceptance/rejection criteria for TFT module.

1 Sample plan

1.1 Lot size: Quantity per shipment lot per model

1.2 Sampling type: Normal inspection,Single sampling

1.3 Inspection level: II

1.4 Sampling table: MIL-STD-105D

1.5 Acceptable quality level (AQL)

Major defect: AQL=0.65

Minor defect: AQL=1.50

2. Inspection condition

2.1 Ambient conditions:

a. Temperature: Room temperature 25± 5℃

b. Humidity: (60± 10) %RH

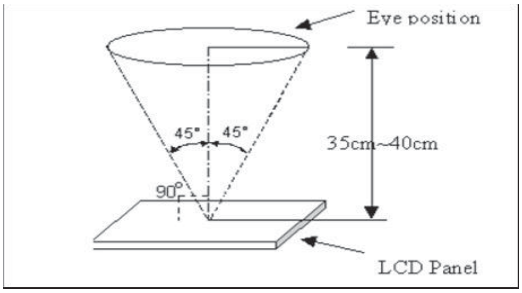
c. Illumination: Single fluorescent lamp non-directive (300 to 700 Lux)

2.2 Viewing distance:

The distance between the LCD and the inspector’ s eyes shall be at least 35± 5cm.

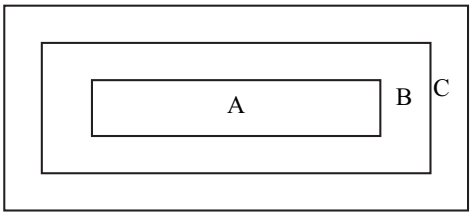
2.3 Viewing Angle

U/D: 45º /45º , L/R: 45º /45º



3. Definition of Inspection Item.

3.1 Definition of inspection zone in LCD.



Zone A: character/Digit area

Zone B: viewing area except Zone A (ZoneA+ZoneB=minimum Viewing area)

Zone C: Outside viewing area (invisible area after assembly in customer’s product)

Fig.1 Inspection zones in an LCD.

OUTGOING QUALITY STANDARD	PAGE 2 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	

Note: As a general rule, visual defects in Zone C are permissible, when it is no trouble for quality and assembly of customer's product.

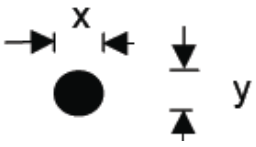
4. Inspection standards

Defects are classified as majot defects and minor defects according to the degree of defectiveness defined herein.

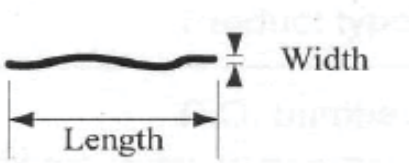
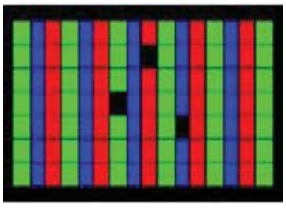
4.1 Major defect

Item No	Items to be inspected	Inspection Standard
4.1.1	All functional defects	1) No display 2) Display abnormally 3) Short circuit 4) Line defect 5) Excess power consumption
4.1.2	Missing	Missing function component
4.1.3	Crack	Glass crack

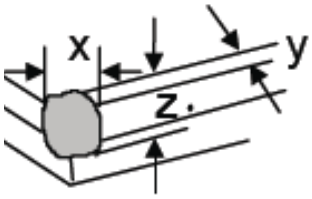
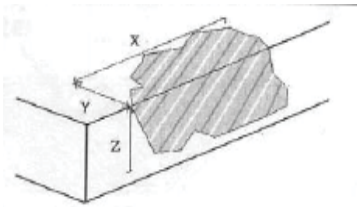
4.2 Minor defect

<table>
<tr><th>Item No</th><th>Items to be inspected</th><th colspan="2">Inspection standard</th></tr>
<tr><td rowspan="5">4.2.1</td><td rowspan="5">Spot Defect
Including
Black spot
White spot
Pinhole
Foreign particle
Polarizer dirt</td><td colspan="2">For dark/white spot is defined
$\varphi = (x+y) / 2$
  </td></tr>
<tr><td>Size φ(mm)</td><td>Acceptable Quantity</td></tr>
<tr><td>φ≤0.15
2mm(min) apart</td><td>Ignore</td></tr>
<tr><td>0.15 < φ≤ 0.25
5mm(min) apart</td><td>3</td></tr>
<tr><td>0.25< φ</td><td>Not allowed</td></tr>
</table>

OUTGOING QUALITY STANDARD	PAGE 3 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	

4.2.2	Line Defect Including Black line White line Scratch	Define: 	
		Width(mm) Length(mm)	Acceptable Quantity
		W≤0.05 and L≤10	Ignore
		0.05 < W≤0.08 and L≤10 3mm(min) apart	3
		0.08 < W≤0.10 andL≤5 3mm(min) apart	1
		0.10< W or 10 < L	Not allowed
4.2.3	Polarizer Dent/Bubble	Size φ(mm)	Acceptable Quantity
		φ≤0.25	Ignore
		Non visible area	Ignore
		0.25< φ≤ 0.40 5mm(min) apart	2
		0.40< φ	Not allowed
4.2.4	Electrical Dot Defect	Bright and Black dot define:  and 	
		Inspection pattern: Full white, Full black, Red, green and blue screens	
		Item	Acceptable Quantity
		Black dot defect	2
		Bright dot defect	0
		Total Dot	2

OUTGOING QUALITY STANDARD	PAGE 4 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	

<table>
<tr><td rowspan="5">4.2.5</td><td rowspan="5">Touch panel chips</td><td colspan="2">1.Corner chips:
  </td></tr>
<tr><td>Size(mm)</td><td>Acceptable Quantity</td></tr>
<tr><td>X≤3mm
Y≤3mm
Z≤T</td><td>Ignore
T: Glass thickness
X: Length
Y: Width
Z: thickness</td></tr>
<tr><td colspan="2">2. Side chips:
  </td></tr>
<tr><td>Size(mm)</td><td>Acceptable Quantity</td></tr>
<tr><td>X≤5mm
Y ≤3mm
Z≤T</td><td>Ignore
T: Glass thickness
X: Length
Y: Width
Z: thickness</td></tr>
</table>

OUTGOING QUALITY STANDARD	PAGE 5 OF 5
TITLE:FUNCTIONAL TEST & INSPECTION CRITERIA	

Note: 1. Dot defect is defined as the defective area of the dot area is larger than 50% of the dot area.

2. The distance between black dot defects or black and bright dot defects should be more than 5mm apart. The distance between two bright dot defects should be more than 15mm apart

3. Polarizer bubble is defined as the bubble appears on active display area. The defect of polarizer bubble shall be ignored if the polarizer bubble appears on the outside of active display area.

4. Mura is checker by 6% ND filter.

5. Foreign particle on the surface of the LCM should be ignore.

■ PRECAUTIONS FOR USING LCD MODULES

Handing Precautions

(1) The display panel is made of glass and polarizer. As glass is fragile. It tends to become or chipped during handling especially on the edges. Please avoid dropping or jarring. Do not subject it to a mechanical shock by dropping it or impact.

(2) If the display panel is damaged and the liquid crystal substance leaks out, be sure not to get any in your mouth. If the substance contacts your skin or clothes, wash it off using soap and water.

(3) Do not apply excessive force to the display surface or the adjoining areas since this may cause the color tone to vary. Do not touch the display with bare hands. This will stain the display area and degraded insulation between terminals (some cosmetics are determined to the polarizer).

(4) The polarizer covering the display surface of the LCD module is soft and easily scratched. Handle this polarizer carefully. Do not touch, push or rub the exposed polarizers with anything harder than an HB pencil lead (glass, tweezers, etc.). Do not put or attach anything on the display area to avoid leaving marks on. Condensation on the surface and contact with terminals due to cold will damage, stain or dirty the polarizer. After products are tested at low temperature they must be warmed up in a container before coming is contacting with room temperature air.

(5) If the display surface becomes contaminated, breathe on the surface and gently wipe it with a soft dry cloth. If it is heavily contaminated, moisten cloth with one of the following solvents

- Isopropyl alcohol
- Ethyl alcohol

Do not scrub hard to avoid damaging the display surface.

(6) Solvents other than those above-mentioned may damage the polarizer. Especially, do not use the following.

- Water
- Ketone
- Aromatic solvents

Wipe off saliva or water drops immediately, contact with water over a long period of time may cause deformation or color fading. Avoid contacting oil and fats.

(7) Exercise care to minimize corrosion of the electrode. Corrosion of the electrodes is accelerated by water droplets, moisture condensation or a current flow in a high-humidity environment.

(8) Install the LCD Module by using the mounting holes. When mounting the LCD module make sure it is free of twisting, warping and distortion. In particular, do not forcibly pull or bend the I/O cable or the backlight cable.

(9) Do not attempt to disassemble or process the LCD module.

(10) NC terminal should be open. Do not connect anything.

(11) If the logic circuit power is off, do not apply the input signals.

(12) Electro-Static Discharge Control，Since this module uses a CMOS LSI, the same careful attention should be paid to electrostatic discharge as for an ordinary CMOS IC. To prevent destruction of the elements by static electricity, be careful to maintain an optimum work environment.

- Before remove LCM from its packing case or incorporating it into a set, be sure the module and your body have the same electric potential. Be sure to ground the body when handling the LCD modules.
- Tools required for assembling, such as soldering irons, must be properly grounded. make certain the AC power source for the soldering iron does not leak. When using an electric screwdriver to attach LCM, the screwdriver should be of ground potentiality to minimize as much as possible any transmission of electromagnetic waves produced sparks coming from the commutator of the motor.
- To reduce the amount of static electricity generated, do not conduct assembling and other work under dry conditions. To reduce the generation of static electricity be careful that the air in the work is not too dried. A relative humidity of 50%-60% is recommended. As far as possible make the electric potential of your work clothes and that of the work bench the ground potential
- The LCD module is coated with a film to protect the display surface. Exercise care when peeling off this protective film since static electricity may be generated

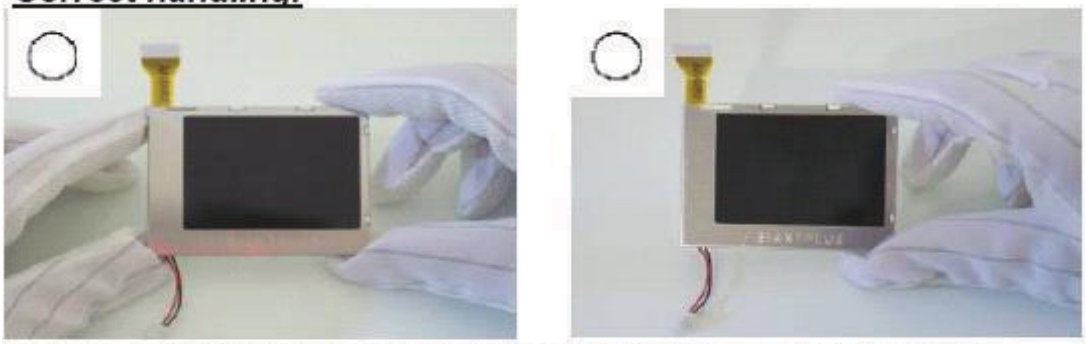
（13）Since LCM has been assembled and adjusted with a high degree of precision, avoid applying excessive shocks to the module or making any alterations or modifications to it.

- Do not alter, modify or change the shape of the tab on the metal frame.
- Do not make extra holes on the printed circuit board, modify its shape or change the positions of components to be attached.
- Do not damage or modify the pattern writing on the printed circuit board.
- Absolutely do not modify the zebra rubber strip (conductive rubber) or heat seal connector.
- Except for soldering the interface, do not make any alterations or modifications with a soldering iron.
- Do not drop, bend or twist LCM.

Handling precaution for LCM

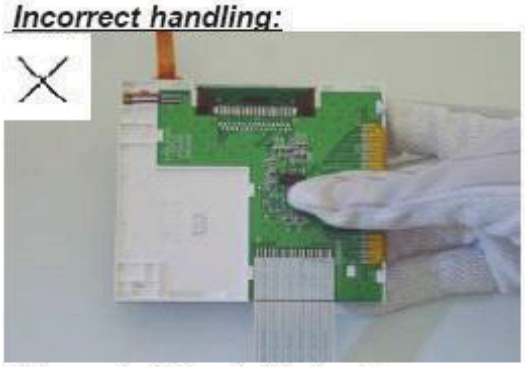
LCM is easy to be damaged.
Please note below and be careful for handling!

Correct handling:

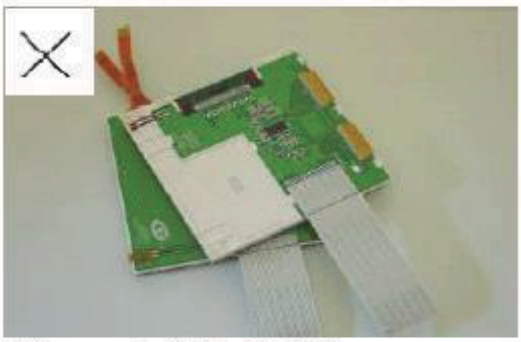


As above picture, please handle with anti-static gloves around LCM edges.

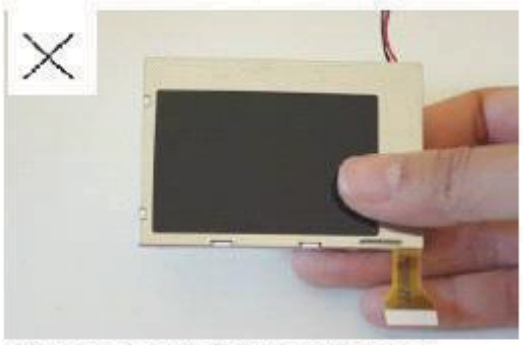
Incorrect handling:



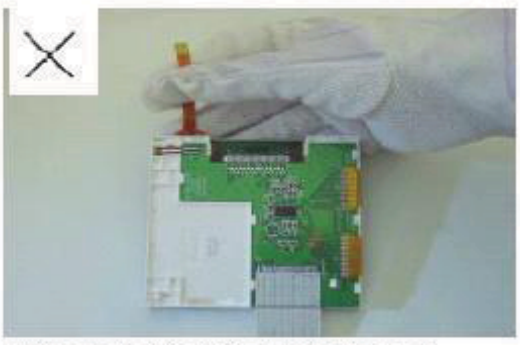
Please don't touch IC directly.



Please don't stack LCM.



Please don't hold the surface of panel.

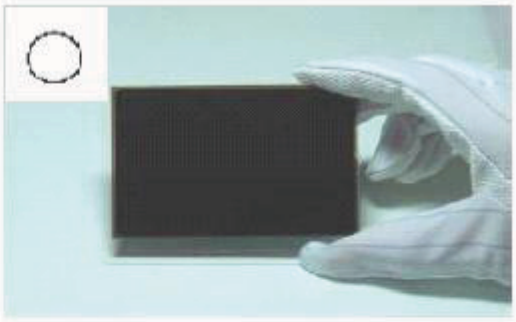


Please don't stretch interface of output, such as FPC cable.

Handling precaution for LCD

LCD is easy to be damaged.
Please note below and be careful for handling!

Correct handling:

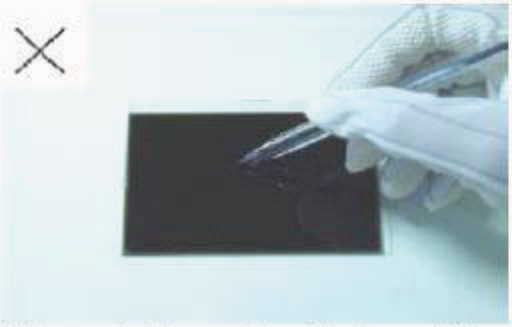


As above photo, please handle with anti-static gloves around LCD edges.

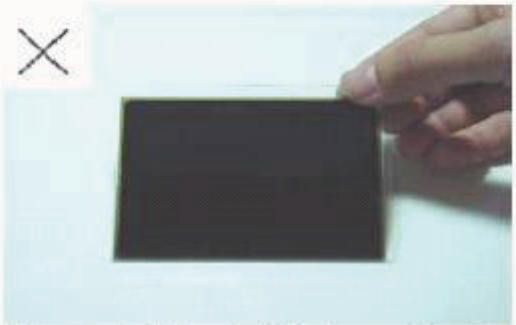
Incorrect handling:

Please don't stack the LCDS.

Please don't hold the surface of LCD.



Please don't operate with sharp stick such as pens.



Please don't touch ITO glass without anti-static gloves.

Storage Precautions

When storing the LCD modules, the following precaution is necessary.

(1) Store them in a sealed polyethylene bag. If properly sealed, there is no need for the dessicant.

(2) Store them in a dark place. Do not expose to sunlight or fluorescent light, keep the temperature between 0°C and 35°C, and keep the relative humidity between 40%RH and 60%RH.

(3) The polarizer surface should not come in contact with any other objects. (We advise you to store them in the anti-static electricity container in which they were shipped.

Others

Liquid crystals solidify under low temperature (below the storage temperature range) leading to defective orientation or the generation of air bubbles (black or white). Air bubbles may also be generated if the module is subject to a low temperature.

If the LCD modules have been operating for a long time showing the same display patterns, the display patterns may remain on the screen as ghost images and a slight contrast irregularity may also appear. A normal operating status can be regained by suspending use for some time. It should be noted that this phenomenon does not adversely affect performance reliability.

To minimize the performance degradation of the LCD modules resulting from destruction caused by static electricity etc., exercise care to avoid holding the following sections when handling the modules.

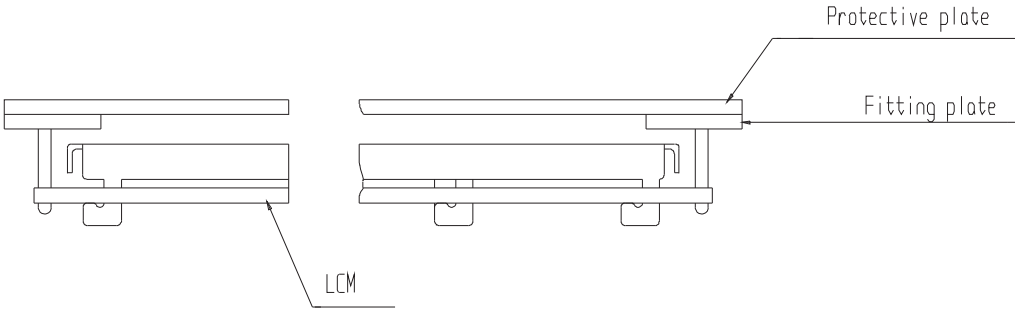
- Exposed area of the printed circuit board.
-Terminal electrode sections.

USING LCD MODULES

Installing LCD Modules

The hole in the printed circuit board is used to fix LCM as shown in the picture below. Attend to the following items when installing the LCM.

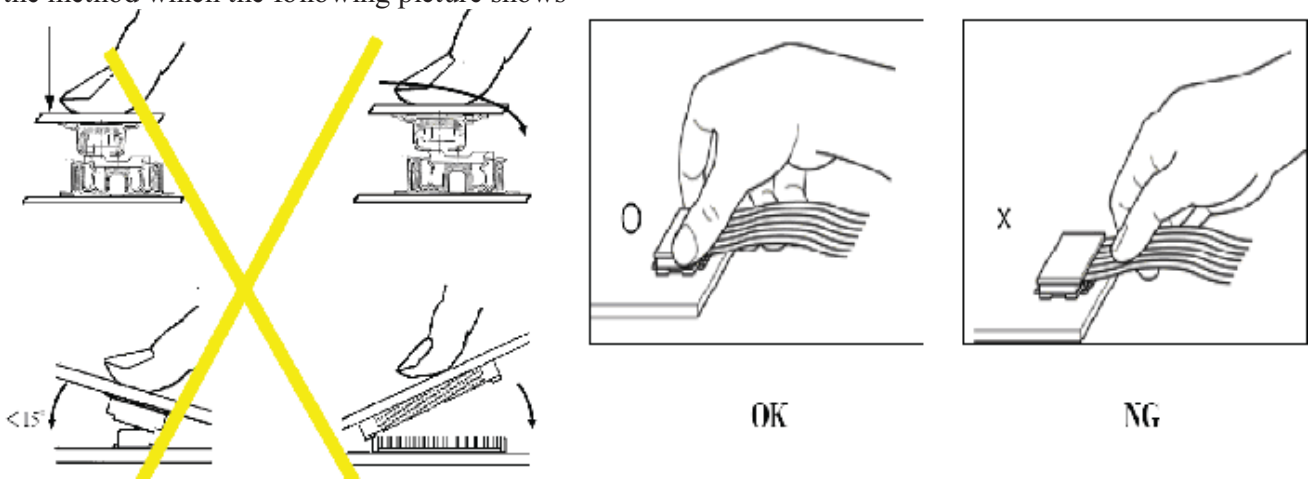
(1) Cover the surface with a transparent protective plate to protect the polarizer and LC cell.



(2) When assembling the LCM into other equipment, the spacer to the bit between the LCM and the fitting plate should have enough height to avoid causing stress to the module surface, refer to the individual specifications for measurements. The measurement tolerance should be ±0.1mm.

Precaution for assemble the module with BTB connector:

Please note the position of the male and female connector position,don't assemble or assemble like the method which the following picture shows



Precaution for soldering to the LCM

	Hand soldering	Machine drag soldering	Machine press soldering
No ROHS product	290°C ~350°C. Time : 3-5S.	330°C ~350°C. Speed : 4-8 mm/s.	300°C ~330°C. Time : 3-6S. Press: 0.8~1.2Mpa
ROHS product	340°C ~370°C. Time : 3-5S.	350°C ~370°C. Time : 4-8 mm/s.	330°C ~360°C. Time : 3-6S. Press: 0.8~1.2Mpa

(1) If soldering flux is used, be sure to remove any remaining flux after finishing to soldering operation. (This does not apply in the case of a non-halogen type of flux.) It is recommended that you protect the LCD surface with a cover during soldering to prevent any damage due to flux spatters.

(2) When soldering the electroluminescent panel and PC board, the panel and board should not be detached more than three times. This maximum number is determined by the temperature and time conditions mentioned above, though there may be some variance depending on the temperature of the soldering iron.

(3) When remove the electroluminescent panel from the PC board, be sure the solder has completely melted, the soldered pad on the PC board could be damaged.

Precautions for Operation

(1) Viewing angle varies with the change of liquid crystal driving voltage (VLCD). Adjust VLCD to show the best contrast.

(2) It is an indispensable condition to drive LCD's within the specified voltage limit since the higher voltage then the limit cause the shorter LCD life. An electrochemical reaction due to direct current causes LCD's undesirable deterioration, so that the use of direct current drive should be avoided.

(3) Response time will be extremely delayed at lower temperature than the operating temperature range and on the other hand at higher temperature LCD's show dark color in them. However those phenomena do not mean malfunction or out of order with LCD's, Which will come back in the specified operating temperature.

(4) If the display area is pushed hard during operation, the display will become abnormal. However, it will return to normal if it is turned off and then back on.

(5) A slight dew depositing on terminals is a cause for electro-chemical reaction resulting in terminal open circuit. Usage under the maximum operating temperature,50%RH or less is required.

(6) Input each signal after the positive/negative voltage becomes stable.

(7) Please keep the temperature within specified range for use and storage. Polarization degradation, bubble generation or polarizer peel-off may occur with high temperature and high humidity.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Safety

(1) It is recommended to crush damaged or unnecessary LCDs into pieces and wash them off with solvents such as acetone and ethanol, which should later be burned.

(2) If any liquid leaks out of a damaged glass cell and comes in contact with the hands, wash off thoroughly with soap and water.

Limited Warranty

Unless agreed otherwise between Display Future Ltd and customer, Display Future will replace or repair any of its LCD modules which are found to be functionally defective when inspected in accordance with LCD acceptance standards (copies available upon request) for a period of one year from date of production. Cosmetic/visual defects must be returned within 90 days of the shipment. Confirmation of such date shall be based on data code on the product.

The warranty liability of Display Future limited to repair and/or replacement on the terms set forth above. Display Future will not be responsible for any subsequent or consequential events.

Return LCM under warranty

No warranty can be granted if the precautions stated above have been disregarded. The typical examples of violations are :

- Broken LCD glass.
- PCB eyelet is damaged or modified.
- PCB conductors damaged.
- Circuit modified in any way, including addition of components.
- PCB tampered with by grinding, engraving or painting varnish.
- Soldering to or modifying the bezel in any manner.

Module repairs will be invoiced to the customer upon mutual agreement. Modules must be returned with sufficient description of the failures or defects. Any connectors or cable installed by the customer must be removed completely without damaging the PCB eyelet, conductors and terminals.

■ PRIOR CONSULT MATTER

1.①For Display Future standard products, we keep the right to change material and processes for improving the product, without notice to our customers.

②For OEM products, if any change is needed, which may affect the product property, we will consult with our customer in advance.

2. If you have special requirement about reliability condition, please let us know before you start the test on our samples.